COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

RAPID THERMAL ANNEALING PROCESS

the specification of whic	ch			
X is attached hereto				
was filed on as Application Serial No and was amended on				
specification, including I acknowledge the application in accordan I hereby claim fore application(s) for pater	the claims, as amende e duty to disclose info ce with Title 37, Code o eign priority benefits un nt or inventor's certific eatent or inventor's cert med:	and understand the content of by any amendment referred from attention which is material to of Federal Regulations, § 1.0 der Title 35, United States Cotate listed below and have difficate having a filing date be	ed to above. the patenta 56(a). Code, § 119 also identifi	ability of th of any foreig ed below ar
Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
92112209	Taiwan, R.O.C.	2003/5/5		X
		(60)		
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COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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